Application Data Sheet

Application information	
Application number::	
Filing Date::	
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	•
Suggested Group Art Unit::	
CD-ROM or CD-R??::	
Number of CD disks::	
Number of copies of CDs::	
Sequence Submission::	
Computer Readable Form (CRF)?::	
Number of copies of CRF::	
Title::	METHOD AND STRUCTURE FOR
	ELECTROSTATIC DISCHARGE PROTECTION
	OF PHOTOMASKS
Attorney Docket Number::	021653-001200US
Request for Early Publication::	No
Request for Non-Publication::	No
Suggested Drawing Figure::	·
Total Drawing Sheets::	9
Small Entity?::	No
Latin name::	
Variety denomination name::	
Petition included?::	No
Petition Type::	
Licensed US Govt. Agency::	
Contract or Grant Numbers One:	

Secrecy Order in Parent Appl.::

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Republic of China

No

Status:: Full Capacity

Given Name:: Kuei-Chi

Middle Name::

Family Name:: Kuo

Name Suffix::

City of Residence:: Shanghai

State or Province of Residence::

Country of Residence:: People's Republic of China

Street of Mailing Address:: 18 Zhang Jiang Road

City of Mailing Address:: Pudong New Area

State or Province of mailing address::

Country of mailing address:: People's Republic of China

Postal or Zip Code of mailing address:: 201203

Correspondence Information

Correspondence Customer Number:: 20350

Representative Information

Representative Customer Number:: 20350

Domestic Priority Information

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

Foreign Priority Information

Country::

Application number::

Filing Date::

People's Republic of China

200310122964.5

12/30/03

Assignee Information

Assignee Name::

Semiconductor Manufacturing International

(Shanghai) Corporation

Street of mailing address::

18 Zhang Jiang Road, Pudong New Area

City of mailing address::

Shanghai

State or Province of mailing address::

Country of mailing address::

People's Republic of China

Postal or Zip Code of mailing address:: 201203